

MS2H32065G1

650V Silicon Carbide Diode

MS2H32065G1

Features

- 650-Volt Schottky Rectifier
- Shorter recovery time
- High-speed switching possible
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on VF

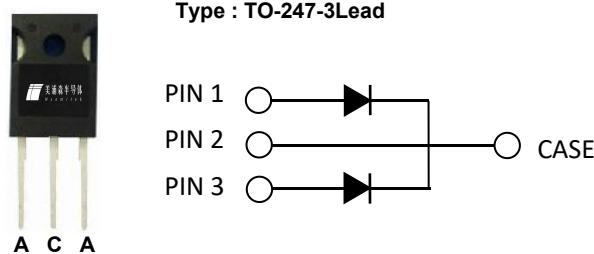
Benefits

- Higher safety margin against overvoltage
- Improved efficiency all load conditions
- Increased efficiency compared to Silicon Diode alternatives
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway
- Essentially No Switching Losses

Applications

- Switch Mode Power Supplies
- Power Factor Correction
- Motor Drives
- PD Power
- Charging Pile Power
- PV Inverter

Package



Absolute Maximum Ratings

$T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	MS2H32065G1	Units
VRRM	Repetitive Peak Reverse Voltage	650	V
VRSM	Surge Peak Reverse Voltage	650	V
VDC	DC Blocking Voltage	650	V
IF	Continuous Forward Current (Per Leg/ Per Device) @ $T_c=150^\circ\text{C}$	16 / 32	A
IFRM	Repetitive Peak Forward Surge Current @ $T_c=25^\circ\text{C}$, tP = 10 ms, Half Sine Wave	105	A
IFSM	Non-Repetitive Peak Forward Surge Current @ $T_c=25^\circ\text{C}$, tP = 10 ms, Half Sine Wave	135	A
IF,Max	Non-Repetitive Peak Forward Surge Current ;@ $T_c=25^\circ\text{C}$, tP= 10 μs , Pulse	1200	A
Ptot	Power Dissipation (Per Leg/Device) @ $T_c=25^\circ\text{C}$ @ $T_c=110^\circ\text{C}$	159 68	W
TJ , Tstg	Operating Junction and Storage Temperature	-55 to +175	°C

Electrical Characteristics

$T_C = 25^\circ C$ unless otherwise noted

Symbol	Test Conditions	Test Conditions	Min	Typ	Max	Unit
VF	Forward Voltage(Per Leg)	IF=16A, TC=25° C IF=16A, TC=175° C	-	1.45 1.75	1.8 3.0	V
IR	Reverse Current	VR=650V, TC=25° C VR=650V, TC=175° C	-	4 40	20 200	µA
QC	Total Capacitive Charge	VR =400V, TJ = 25° C $Qc = \int_0^{V_R} C(V) dv$	-	41	-	nC
C	Total Capacitance	VR =0V, TJ = 25° C, f=1MHz VR =200V, TJ = 25° C, f=1MHz VR =400V, TJ = 25° C, f=1MHz	-	860 85 60	-	pF
EC	Capacitance Stored Energy	VR=400V	-	8.2	-	µJ

Thermal Characteristics

Symbol	Parameter	Typ	Unit
R _{θJC}	Thermal Resistance from Junction to Case	0.94	°C/W

Typical Characteristics

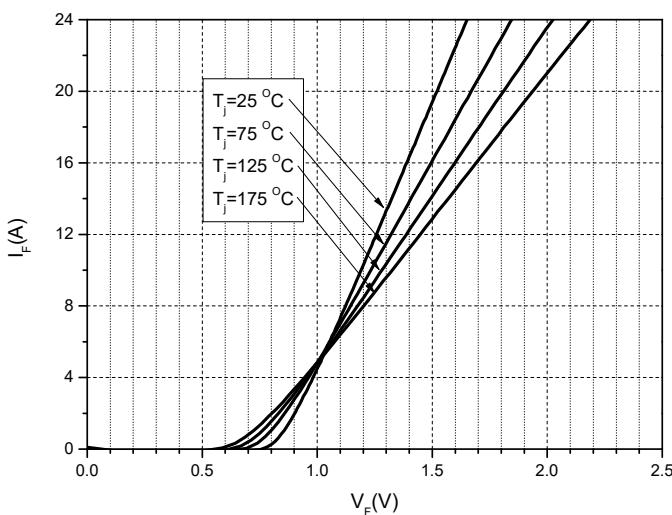


Figure 1. Forward Characteristics

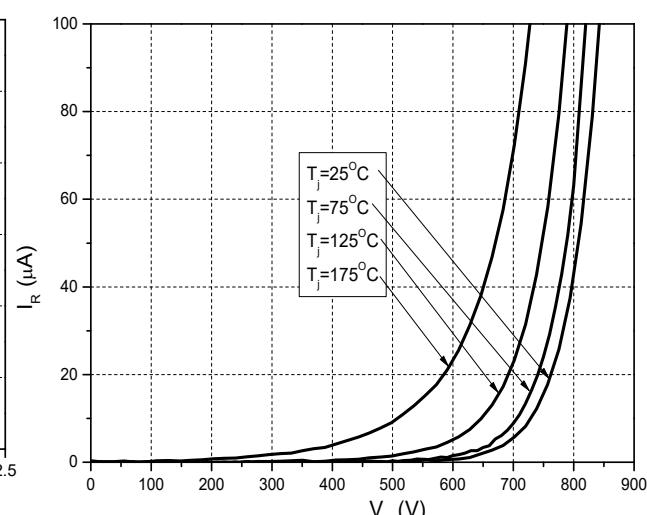


Figure 2. Reverse Characteristics

Typical Characteristics

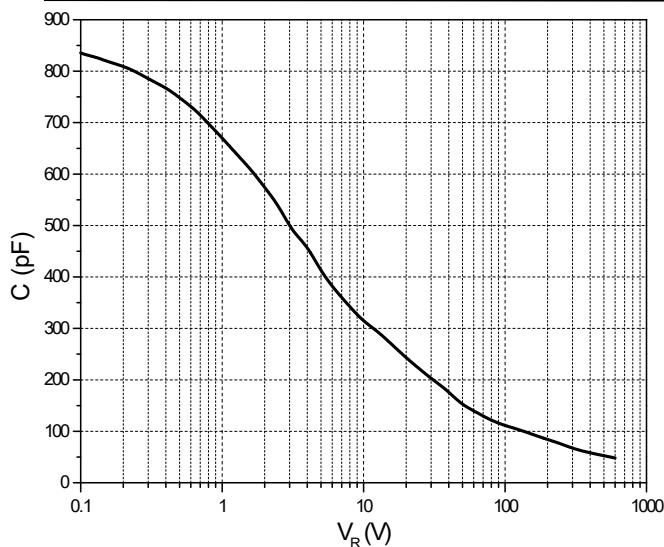


Figure 3. Capacitance vs. Reverse Voltage

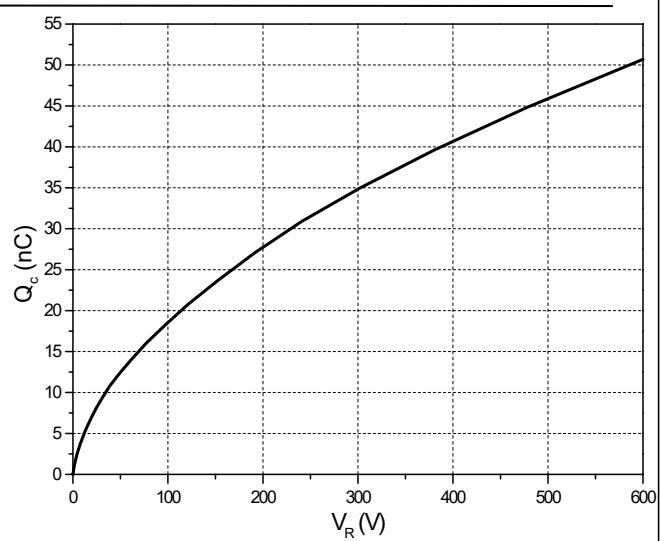


Figure 4. Total Capacitance Charge vs. Reverse Voltage

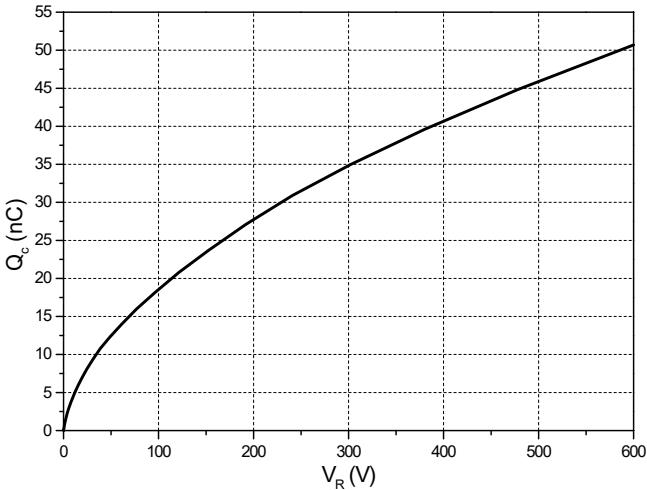


Figure 5. Capacitance Stored Energy

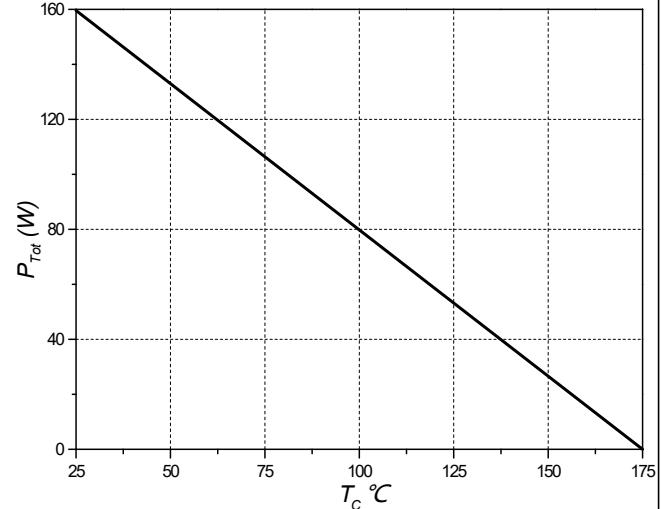


Figure 6. Power Derating

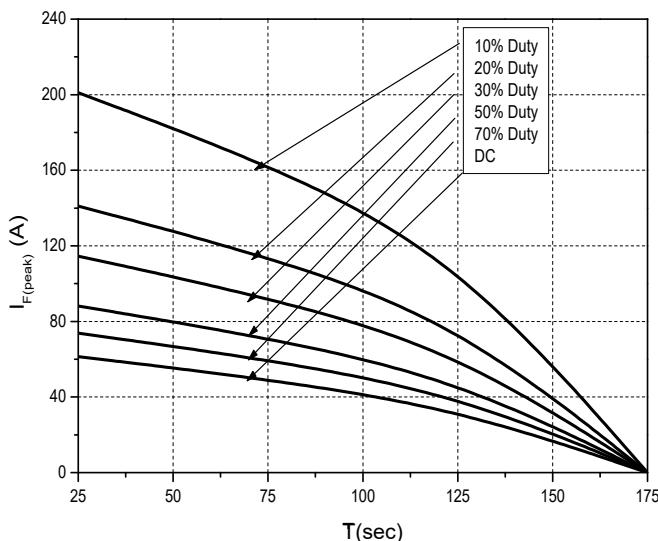


Figure 7. Current Derating

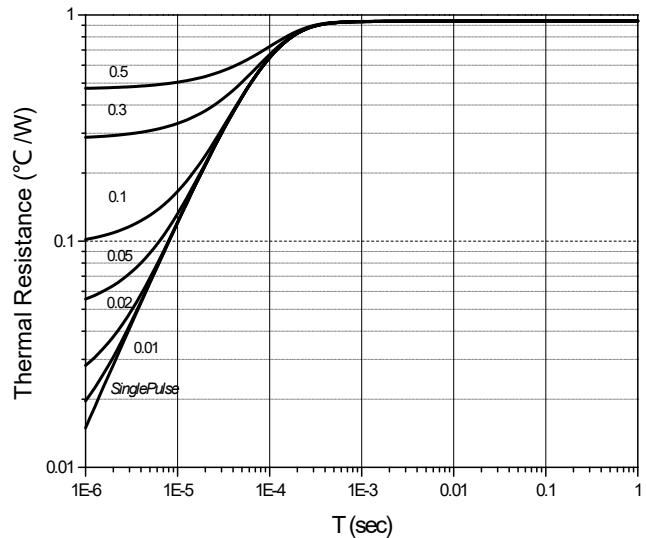
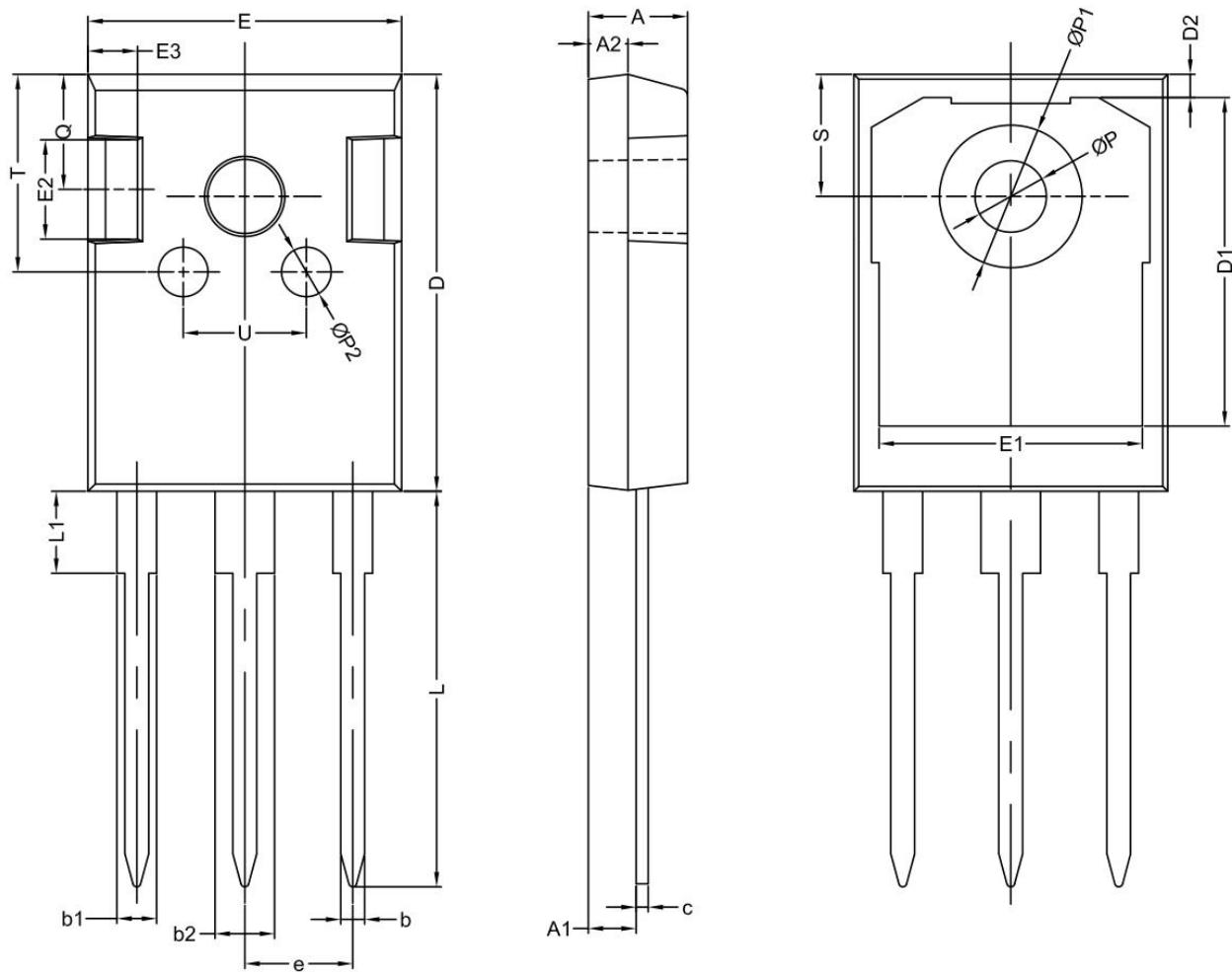


Figure 8. Transient Thermal Impedance

TO-247 OUTLINE



SYMBOL	Mechanical Dimensions/mm			SYMBOL	Mechanical Dimensions/mm			SYMBOL	Mechanical Dimensions/mm		
	MIN	NOM	MAX						MIN	NOM	MAX
A	4.80	5.00	5.20	D	20.80	21.00	21.20	L1	-	4.13	-
A1	2.21	2.41	2.61	D1	-	16.55	-	$\varnothing P$	3.5	3.6	3.7
A2	1.90	2.00	2.10	E	15.60	15.80	16.0	$\varnothing P_1$	-	-	7.40
b	1.10	1.20	1.35	E1		13.3		$\varnothing P_2$	-	2.50	-
b1	-	2.00	-	E2		5.0		Q	-	5.8	-
b2	-	3.00	-	e	5.44			S	6.05	6.15	6.25
c	0.55	0.60	0.75	L	19.42	19.92	20.42	T	-	10.0	-

NOTE:

1.The plastic package is not marked as smooth surfaceRa=0.1;Subglossy surfaceRa=0.8
 2.Undeclared tolerance ± 0.25 , Unmarked filletRmax=0.25

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